PCN Number:		202	20220331000.0				PCN Date:	April 26, 2022	
Title: Pin one ID ch			nange for select devices						
Cus	tomer Contact	: <u>PCN</u>	<u>Manager</u>	Dept:	Quality Se	ervices			
Cha	nge Type:								
	Assembly Site		Assembly Process			[	Assembly Materials		
Design			Datasheet				Mechanical Specification		
Test Site		5	Packing/Shipping/Labeling					Test Process	
Wafer Bump Site			Wafer Bump Material					Wafer Bump Process	
Wafer Fab Site			Wafer Fab Materials				Wafer Fab Process		
			Part number change			L			
					Details				
Dec	crintion of Ch	ander			Details				
<b>Description of Change:</b> This letter is to inform customers of a pin one id change for select devices as shown below:									
11115		ini cusic	JIIIEIS UI		lu change h	UI SEIE	ct devices as	S SHOWIT DEIOW.	
MAF	RKING PIN1 CHA				INE TO SH				
		FROM	ROM (circular outline pin 1)			TO (shaded circular pin 1)			
8 1									
	8 NMB	7 []	МТ	ang.	MT I		TM7L		
		$\Box \gamma$		I II CA	1745		17117	RULLIF 2	
			A LL	.4			JAW		
			ΑW	OU	10	Q	ШАШ		
				TOP-CONTROL					
11		100					0.0	100	
	11 ZWA	1G2					GZ		
		1 A W	Ĩ.	VAR	e l	-	$\wedge \wedge \wedge$	VILLO	
				THE R	3		/-\ VV	<b>MARKED</b>	
		0		C		0			
				COLOR SHE					
				30				JGMA	
			ΗWW		12963		2966		
	20 NME	٦.	A [.]	VA	96			VNO	
		<u> </u>			120				
				Energiese State				and the second second	
Rea	son for Chang	e:							
	ndardization								
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
Non	e								
Cha	nges to produ	ct iden	tificatio	n resulting	g from this	s PCN:			
Added device symbolization row									
	duct Affected:								
T	V8601NMBR	Тр	1620241	TYBOLOOM	TXB0108NMER TXS0108ENMER				
						30108NMER TXS0108ENMER			
I SN	74AVC4T234ZWA	R TPA	46205A1N	MBR					

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail				
WW Change Management Team	PCN ww admin team@list.ti.com				

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